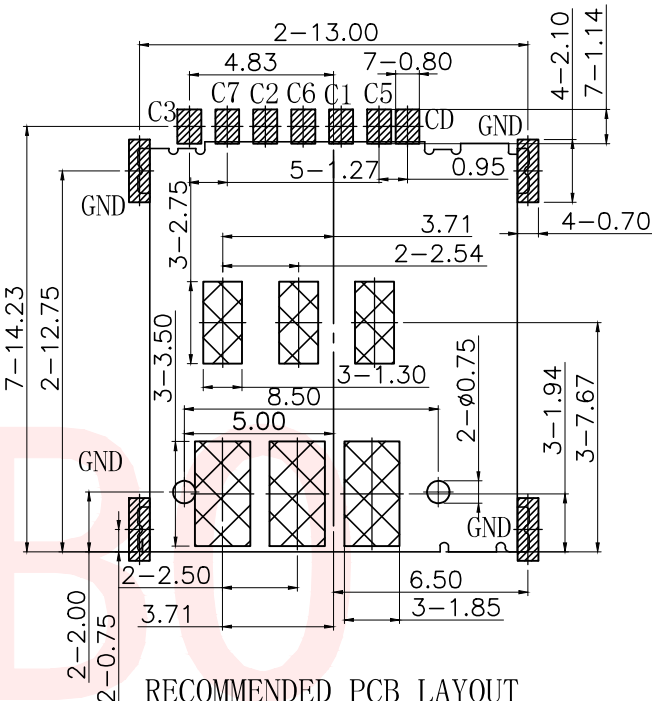
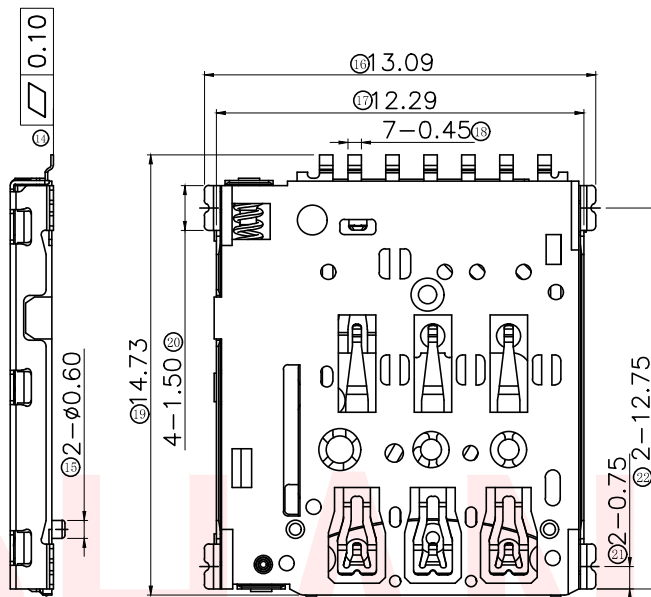
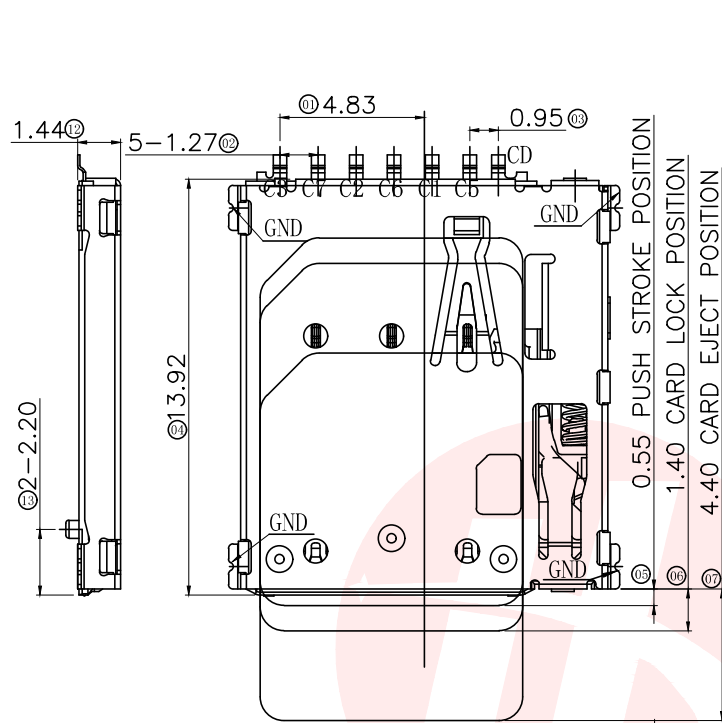


REV.	ECN NO OR DESCRIPTION	REVISED	DATE



RECOMMENDED PCB LAYOUT

TOLERANCE: ± 0.05

SMT SOLDER AREA

COPPER RESTRICTED AREA

- TOUCH AREA OF CONTACT
TIPS NO ELECTRICAL FUNCTION
- NO FIRST PCB_LAYOUT
CIRCUITS IN THE AREA

Notes:

- Material:
Housing: High Temperature Thermoplastic
Terminal: Copper Alloy
Shell: Stainless Steel
- Plating:
Terminal: 50u" Ni Underplated Overall
G/F Plated On Contact Area
G/F Plated On Solder Area
Shell: 30u" Ni Underplated Overall
G/F Plated On Contact Area And Solder Area
- Technical Speciality:
Rated Voltage: 30V
Current Rating: 0.5A
Insulation Resistance: 1000M Ω Min.
Contact Resistance: 100m Ω Max.
Withstanding Voltage: 500V DC For 1 Minutes.
Operating Temperature: -40 $^{\circ}$ C~+75 $^{\circ}$ C Humidity 80% R.H.Max.

卡片尺寸
2:1

PIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
CD	Detect Switch

UNLESS OTHERWISE
SPECIFIED TOLERANCES

DECIMALS: ANGLES:
X ± 0.30 X $\pm 2^{\circ}$
X.X ± 0.20 X.X $\pm 1^{\circ}$
X.XX ± 0.10



东莞市汉博电子科技有限公司
DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	1. 37H Push-Push Nano-SIM防飞卡座			
DWN	xiong	SNO-1351AX		
CHKD	lee	SCALE: 1:1	UNIT: mm	
APVD	wang	SIZE: A4	SHEET: 1 OF 1	REV: A4
CUSTOMER COPY				